

CDR04BX563BKUS

Aliases (C1812P563K1XSL, CDR04BX563BKZS, CDR04BX563BKWS)

SMD Mil PRF55681, Ceramic, 0.056 uF, 10%, 100 VDC, BX, Ceramic Chips, MIL PRF 55681 Established Reliability, S (0.001%/1000 Hrs), 1812 / 4532



Click [here](#) for the 3D model.

General Information

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|-------------------------|--|
| Series | SMD Mil PRF55681 |
| Style | SMD Chip |
| Description | Ceramic Chips, MIL PRF 55681 Established Reliability |
| RoHS | No |
| Prop 65 | WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov/ |
| Termination | Lead (SnPb) |
| Failure Rate | S (0.001%/1000 Hrs) |
| Testing and Reliability | MIL-PRF-55681 |
| Qualifications | MIL-PRF-55681 |
| Shelf Life | 78 Weeks |
| MSL | 1 |

Dimensions

| | |
|----------------------|------------------|
| L | 4.57mm +/-0.38mm |
| W | 3.18mm +/-0.38mm |
| T | 2.03mm MAX |
| B | 0.51mm +/-0.25mm |
| Case Code (EIA / mm) | 1812 / 4532 |

Packaging Specifications

| | |
|--------------------|-----------|
| Packaging | Bulk, Bag |
| Packaging Quantity | 7500 |

Specifications

| | |
|---------------------------------|------------|
| Capacitance | 0.056 uF |
| Tolerance | 10% |
| Voltage DC | 100 VDC |
| Dielectric Withstanding Voltage | 250 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | BX |
| Dissipation Factor | 2.5% |
| Insulation Resistance | 100 GOhms |

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